

## **Customer Information Notification**

Issue Date: 11-Sep-2019 Effective Date: 14-Oct-2019

Here's your personalized quality information concerning products Digi-Key purchased from NXP. For detailed information we invite you to view this notification online

This notice is NXP Company Proprietary.

# 201908013I



Change Category				
[] Wafer Fab Process	[] Assembly Process	[] Product Marking	[X] Test Location	[] Design
[] Wafer Fab Materials	[] Assembly Materials	[] Mechanical Specification	[]Test Process	[] Errata
[] Wafer Fab Location	[] Assembly Location	[] Packing/Shipping/Labeling	[] Test g Equipment	[] Electrical spec./Test coverage
[] Firmware	[] Other			Ŭ

i.MX6ULL and i.MX6UltraLite Final Test Site Expansion from NXP-ATTJ to ASECL

## **Description**

NXP Semiconductors announces the Final Test site expansion for the i.MX6ULL and i.MX6UltraLite product associated with this notification, from the current NXP-ATTJ Tianjin, China Final Test site to the ASE, Chung-Li, Taiwan Final Test site.

Final Test site expansion was successfully qualified adhering to NXP specifications.

#### Reason

Qualification of ASE, Chung-Li, Taiwan is required for manufacturing flexibility and customer supply assurance.

#### **Identification of Affected Products**

Product identification does not change

## Anticipated Impact on Form, Fit, Function, Reliability or Quality

No impact on form, fit, function, reliability or quality.

## **Disposition of Old Products**

NXP will reserve the right to ship from any location based on market demand situation.

#### **Contact and Support**

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus. Passion to Win.

NXP Quality Management Team.

## **About NXP Semiconductors**

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

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**NXP Semiconductors** 

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Affected Part		Affected Part	
<u>Numbers</u>	Affected 12NC	<u>Numbers</u>	Affected 12NC
MCIMX6Y2DVM05AA	935313074557	MCIMX6G1CVM05AB	935346153557
MCIMX6Z0DVM09AB	935377904557	MCIMX6G2CVM05AB	935346156557
MCIMX6G3DVM05AA	935316313557	MCIMX6G2DVM05AB	935346157557
MCIMX6Y2CVM05AA	935318725557	MCIMX6G3CVM05AB	935346158557
MCIMX6G2DVM05AA	935318783557	MCIMX6G3DVM05AB	935346159557
MCIMX6Y1CVM05AA	935320915557	MCIMX6Y1CVM05AB	935354638557
MCIMX6Y2CVM08AA	935340995557	MCIMX6Y2CVM08AB	935357248557
MCIMX6Y2DVM09AA	935346022557	MCIMX6Y2DVM05AB	935357251557
MCIMX6Y7DVM09AA	935346023557	MCIMX6Y2DVM09AB	935357252557